

Applications

- Point to Point Radio / VSAT
- Millimeter-wave Communications
- Test Equipment



32-pin 5x5mm package

Product Features

Frequency range: 12.5 – 13.5 GHz

• Tune Voltage: 1 – 13 V

Output power: 7 dBm Typical

Phase Noise: -110 dBc/Hz@100 KHz Typical

-133 dBc/Hz@1 MHz Typical

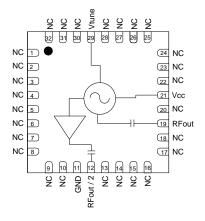
• RFout/2 Frequency Range: 6.25 – 6.75 GHz

RFout/2 Output Power: 6 dBm Typical
Bias: Vcc = 5V, Icc = 165 mA Typical

Technology: TriQuint HBT

Dimension: 5 x 5 x 0.85 mm SLP

Functional Block Diagram



General Description

The TriQuint TGV2529-SM is a monolithic voltage controlled oscillator (VCO) designed to operate at frequencies that target the Point to Point, VSAT, and millimeter-wave communication markets.

The TGV2529-SM is manufactured on TriQuint's GaAs InGaP production process and typically provides 7 dBm output power at 13GHz with a -110dBc/Hz phase noise at 100 KHz offset. A divide-by-2 output is provided for the PLL function.

Lead-free and RoHS compliant.

Evaluation Boards are available upon request.

Pin Configuration

| Pin # | Function Label |
|--|----------------|
| 11 | GND |
| 12 | RFout/2 |
| 19 | RFout |
| 21 | Vcc |
| 29 | Vtune |
| 1, 2, 3, 4, 5, 6, 7, 8, 9, 10, 13, 14, 15, 16, 17, 18, 20, 22, 23, 24, 25, 26, 27, 28, 30, 31, 32 | NC |

Ordering Information

| Part No. | ECCN | Description |
|------------|-------|---|
| TGV2529-SM | EAR99 | 12.5 – 13.5 GHz VCO with Divide by 2 |

Standard T/R size = 500 pieces on a 7.0" reel.



Specifications

Absolute Maximum Ratings

| Parameter | Rating |
|--------------------------|--------------|
| Supply Voltage, Vcc | +5.5V |
| Tuning Voltage, Vtune | +14V |
| Power Dissipation, Pdiss | 1.1W |
| Junction Temperature | 200°C |
| Storage Temperature | -65 to 125°C |

Operation of this device outside the parameter ranges given above may cause permanent damage.

Recommended Operating Conditions

| Parameter | Min | Тур | Max | Units |
|-----------------------|-----|-----|-----|-------|
| Operating Temp. Range | -40 | +25 | +85 | °C |
| Supply Voltage, Vcc | 4.8 | 5.0 | 5.2 | V |
| Supply Current, Icc | | 165 | | mA |
| Tuning Voltage, Vtune | 1 | | 12 | V |

Electrical specifications are measured at specified test conditions. Specifications are not guaranteed over all recommended operating conditions.

Electrical Specifications

Test conditions unless otherwise noted: 25 °C, Vcc = 5 V, Icc = 165mA

| Parameter | Conditions | Min | Тур | Max | Units |
|---|-------------|------|----------------|------|-----------|
| Operational Frequency | | 12.5 | | 13.5 | GHz |
| RFout/2 Output Frequency | | 6.25 | | 6.75 | GHz |
| Supply Voltage, Vcc | | 4.8 | 5 | 5.2 | V |
| Supply Current, Icc | | 140 | 165 | 190 | mA |
| Output Power | | 4 | 7 | 12 | dBm |
| RFout/2 Output Power | | 2 | 6 | 10 | dBm |
| Tuning Sensitivity | Vtune = 5V | | 175 | | MHz/V |
| Output Return Loss | | | 7 | | dB |
| RFout/2 Output Return Loss | | | 5 | | dB |
| Tuning Voltage | | 1 | | 13 | V |
| Pushing | Vtune = 5V | | 10 | | MHz/V |
| Pulling | VSWR 2:1 | | 5 | | MHz (p-p) |
| Harmonics Freq/2 3*Freq/2 2*Freq | | | 21 30 49 | | dBc |
| Phase Noise @ 10KHz Offset | Vtune = 5V | | -80 | | dBc/Hz |
| Phase Noise @ 100KHz Offset | Vtune = 5V | | -110 | | dBc/Hz |
| Phase Noise @ 1MHz Offset | Vtune = 5V | | -133 | | dBc/Hz |
| Frequency Drift Rate | | | 1.1 | | MHz/°C |
| Vtune Leakage | Vtune = 12V | | 5 | | μA |

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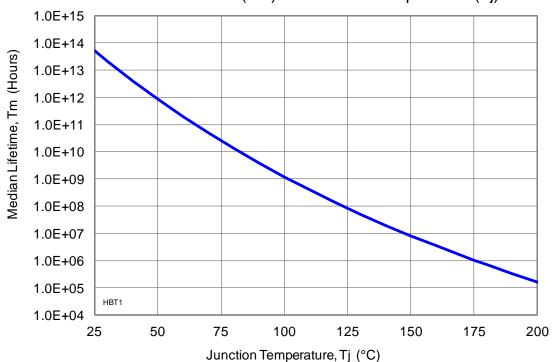


Specifications

Thermal and Reliability Information

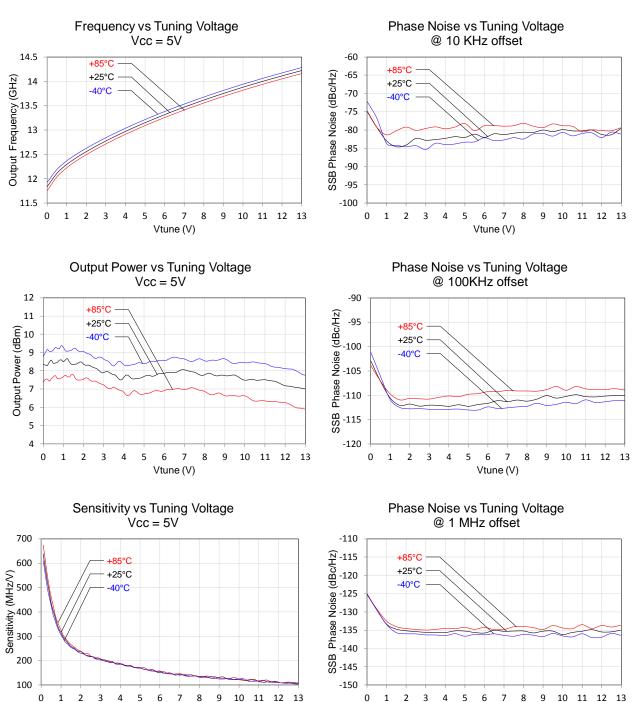
| Parameter | Condition | Rating |
|--|-------------------------------------|--|
| Thermal Resistance, θ_{JC} , measured to back of package | Tbase = 85 °C | $\theta_{JC} = 48 ^{\circ}\text{C/W}$ |
| Junction Temperature (Tj), and Median Lifetime (Tm) | Tbase = 85 °C Vd = 5V Id = 165mA | Tch = 125 °C Tm = 8.4 E+7 Hours |

Median Lifetime (Tm) vs. Junction Temperature (Tj)





Typical Performance

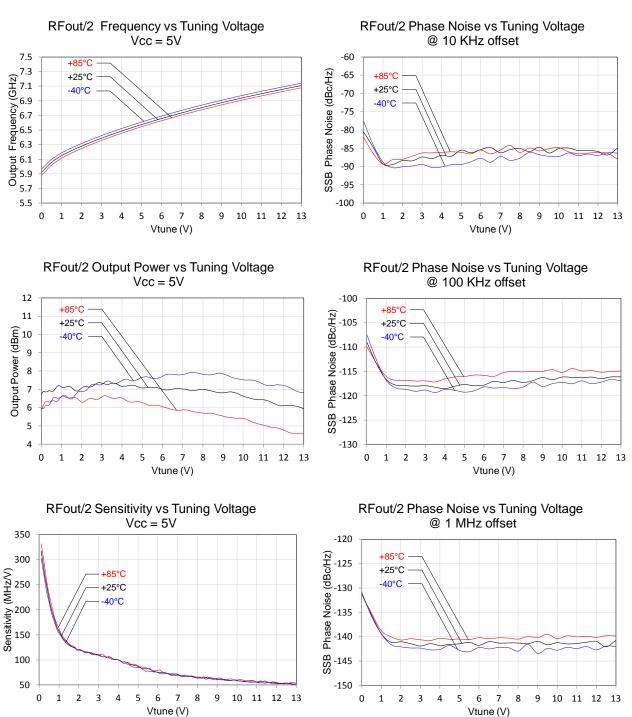


Vtune (V)

Vtune (V)



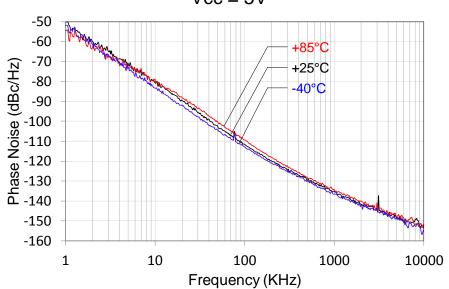
Typical Performance



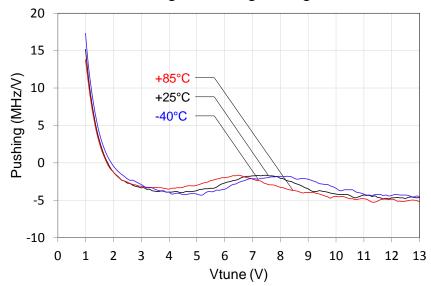


Typical Performance

Phase Noise vs Tuning Voltage Vcc = 5V

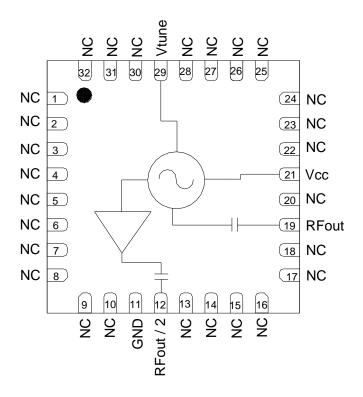


Pushing vs Tuning Voltage





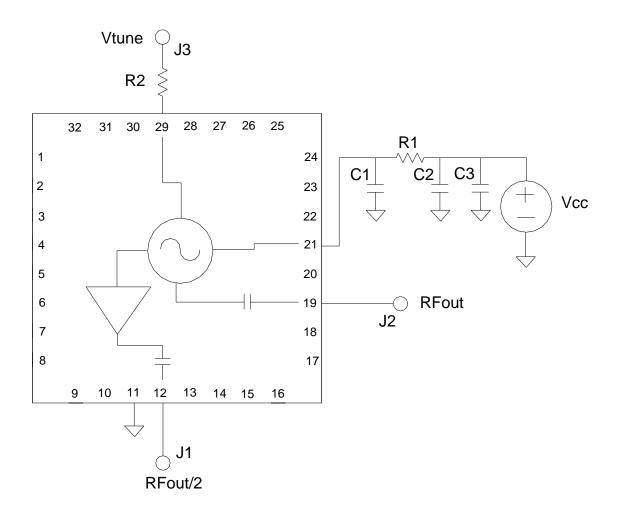
Pin Description



| Pin | Symbol | Description |
|---|---------|---|
| 1, 2, 3, 4, 5, 6, 7, 8, 9, 10, 13, 14, 15, 16, 17, 18, 20, 22, 23, 24, 25, 26, 27, 28, 30, 31, 32 | NC | No internal connection. |
| 11 | GND | Backside Paddle. Multiple vias should be employed to minimize inductance and thermal resistance |
| 12 | RFout/2 | Frequency/2 Output match to 50 ohms, AC coupled |
| 19 | RFout | Output, matched to 50 ohms, AC coupled |
| 21 | Vcc | Supply voltage. Bias network is required; see Application Circuit on page 8 as an example. |
| 29 | Vtune | VCO tuning voltage. |



Application Circuit



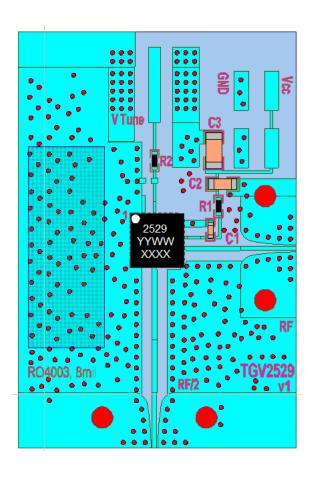


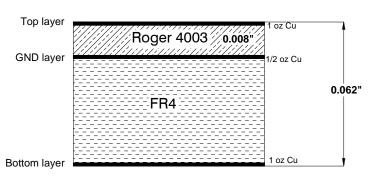
Application Circuit

PC Board Layout

Top RF layer is 0.008" thick Roger RO4003, $\varepsilon_r = 3.38$. Microstrip 50Ω line detail: width =0.0175". For further technical information, refer to the <u>TGV2529-SM</u> Product Information page.

The pad pattern shown has been developed and tested for optimized assembly at Triquint Semiconductor. The PCB land pattern has been developed to accommodate lead and package tolerance. Since surface mount processes vary from company to company, careful process development is recommended.







Bill of Material

| Ref Des | Value | Description | Manufacturer | Part Number |
|---------|--------|-------------------------|--------------|-------------|
| C1 | 100 pF | Ceramic Cap, 0402 | various | |
| C2 | 1 µF | Ceramic Cap, 0603 | various | |
| C3 | 10 μF | Tantalum Cap, 0805/1206 | various | |
| R1, R2 | 0 ohm | Chip Res, 0402 | various | |

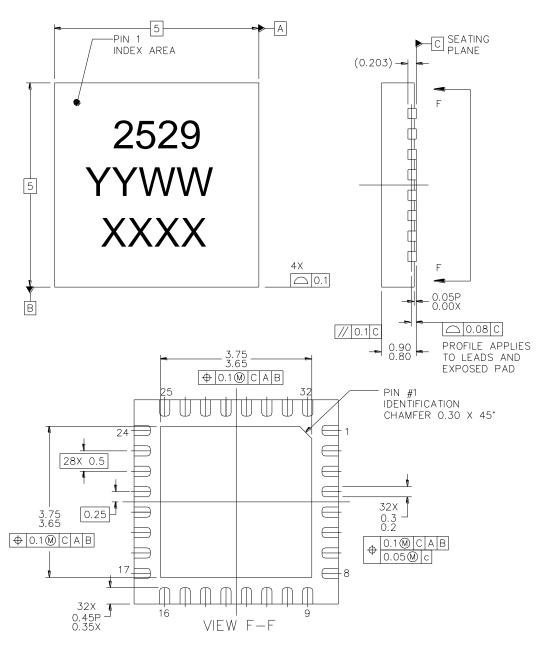
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Mechanical Information

Package Marking and Dimensions

All dimensions are in millimeters.



This package is lead-free/RoHS-compliant. The package base is copper alloy and the plating material on the leads is 100% matte Sn. It is compatible with both lead-free (maximum 260 °C reflow temperature) and tin-lead (maximum 245 °C reflow temperature) soldering processes.

The TGV2529-SM will be marked with the "2529" designator and a lot code marked below the part designator. The "YY" represents the last two digits of the year the part was manufactured, the "WW" is the work week, and the "XXXX" is last 4 digits of lot number.

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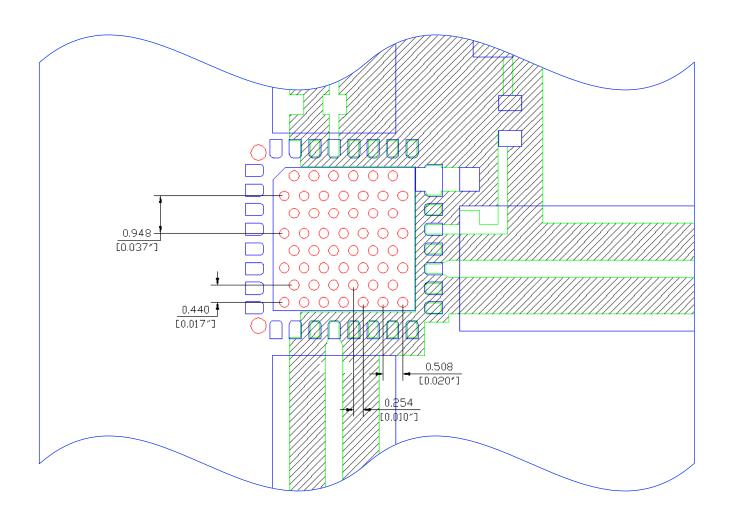
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Mechanical Information

PCB Mounting Pattern

All dimensions are in millimeters [inches].



Notes:

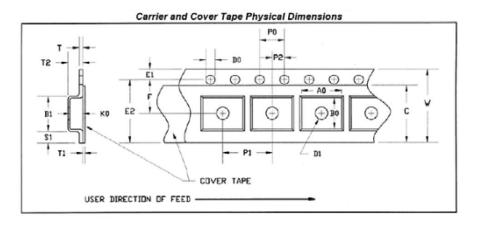
- 1. The pad pattern shown has been developed and tested for optimized assembly at TriQuint Semiconductor. The PCB land pattern has been developed to accommodate lead and package tolerances. Since surface mount processes vary from company to company, careful process development is recommended.
- 2. Ground / thermal vias are critical for the proper performance of this device. Vias have a final plated thru diameter of .25 mm (.010").



Tape and Reel Information

Tape and reel specifications for this part are also available on the TriQuint website in the "Application Notes" section.

Standard T/R size = 500 pieces on a 7.0" reel.



CARRIER AND COVER TAPE DIMENSIONS

| Part | Feature | Symbol | Size (in) | Size (mm) |
|--------------------------------|--|--------|-----------|-----------|
| Cavity | Length | A0 | 0.207 | 5.25 |
| | Width | B0 | 0.207 | 5.25 |
| | Depth | K0 | 0.043 | 1.1 |
| | Pitch | P1 | 0.315 | 8.00 |
| Distance Between Centerline | Cavity to Perforation Length Direction | P2 | 0.079 | 2.00 |
| | Cavity to Perforation Width Direction | F | 0.217 | 5.50 |
| Cover Tape | Width | С | 0.374 | 9.50 |
| Carrier Tape | Width | W | 0.472 | 12.00 |



Product Compliance Information

ESD Information



Caution! ESD-Sensitive Device

ESD Rating: Class 0

Value: Passes ≥ 200V min
Test: Human Body Model (HBM)
Standard: JEDEC Standard JESD22-A114

MSL Rating

Moisture Sensitivity Level (MSL) 3 at 260°C convection reflow per JEDEC standard IPC/JEDEC J-STD-020.

Solderability

Compatible with both lead-free (260 °C max. reflow temp.) and tin/lead (245 °C max. reflow temp.) soldering processes.

Package lead plating: matte Sn

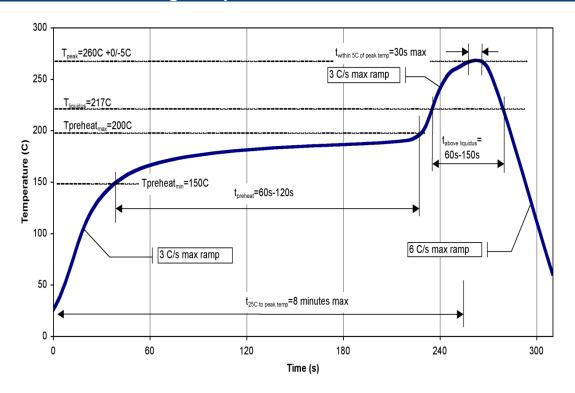
RoHS Compliance

This part is compliant with EU 2002/95/EC RoHS directive (Restrictions on the Use of Certain Hazardous Substances in Electrical and Electronic Equipment).

This product also has the following attributes:

- Lead Free
- Halogen Free (Chlorine, Bromine)
- Antimony Free
- TBBP-A (C₁₅H₁₂Br₄O₂) Free
- PFOS Free
- SVHC Free

Recommended Soldering Temperature Profile



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TGV2529-SM

12.5 – 13.5 GHz VCO with Divide by 2



Contact Information

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